



# TAI-SAW TECHNOLOGY CO., LTD.

No. 3, Industrial 2nd Rd., Ping-Chen Industrial District,  
Taoyuan, 324, Taiwan, R.O.C.

TEL: 886-3-4690038 FAX: 886-3-4697532

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## Product Specifications Approval Sheet

Product Description: VCXO SMD 7.0x5.0 36MHz

TST Part No.: TX0215A

Customer Part No.: \_\_\_\_\_

Customer signature required
Company: _____
Division: _____
Approved by : _____
Date: _____

Checked by: \_\_\_\_\_ Ginger Huang *Ginger Huang*

Approved by: \_\_\_\_\_ Kelly Huang *Kelly Huang*

Date: \_\_\_\_\_ 08/08/2012

1. Customer signed back is required before TST can proceed with sample build and receive orders.
2. Orders received without customer signed back will be regarded as agreement on the specifications.
3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



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## SMD 7.0x5.0 36MHz VCXO

MODEL NO.: TX0215A

REV. NO.: 2.0

### Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Reviser
1	N/A	Initial release	01/05/07'	N/A	Ryan Huang
2	P4	Change Mechanical Dimensions	08/08/12'	1.0	Ginger Huang



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## 7.0x5.0 VCXO 36MHz

MODEL NO.: TX0215A

REV. NO.:2.0

### Features:

1. 3.3V Operation / Complementary HCMOS Output
2. Enable / Disable Tristate Function (6-Pad)
3. Main application: WLAN, SONET/SDH/DWDM, Gigabite Ethernet, Storage Area Network, Digital Video

RoHS Compliant  
Lead free  
Lead-free soldering

### Electrical Specifications:

Measurement shall be made under room temperature and humidity at below conditions.

Temperature: 25+/-3 °C

Humidity: Below 70% RH

Operating Temperature: -40 °C to +85 °C

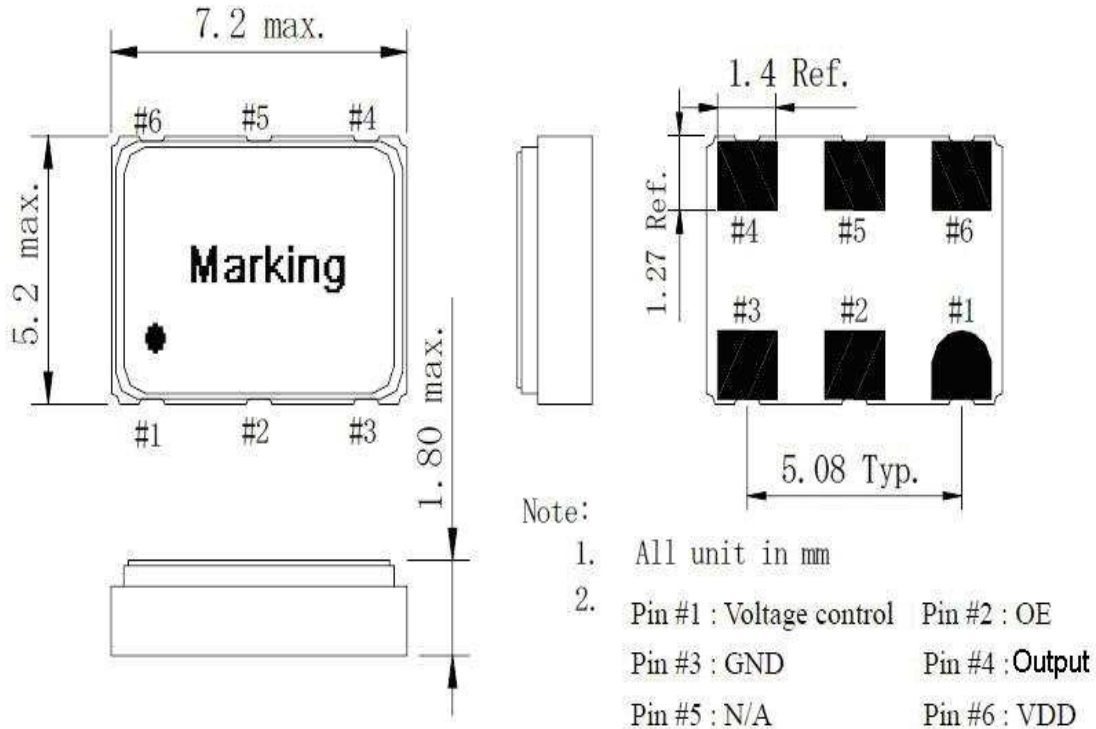
Storage Temperature: -40 °C to +85 °C

Characteristics	Units	Minimum	Typical	Maximum
Center Frequency	<b>MHz</b>	-	36	-
Frequency Stability	<b>ppm</b>	-50	-	50
Input Voltage (Operating Vdd)	<b>VDC</b>	-	3.3+/-5%	-
Control Voltage (Vt)	<b>VDC</b>	0.15	1.65	3.15
Current Consumption	<b>mA</b>	-	-	20
Frequency Pullability	<b>ppm</b>	+/-100	-	-
Linearity	<b>%</b>	-	10%	-
<b>Output</b>				
Load	<b>ohm</b>	-	15	-
"0" Level (Vol)	<b>VDC</b>	-	-	0.33
"1" Level (Voh)	<b>VDC</b>	2.97	-	-
Duty Cycle	<b>%</b>	45%	-	55%
Rise Time (10%->90% VDD)	<b>nSec</b>	-	-	6
Fall Time (90%->10% VDD)	<b>nSec</b>	-	-	6
Enable/Disable Function		PIN#2: High or Open , PIN#4: Enable PIN#2: Low , PIN#4: Disable		
Package size		SMD7.0x5.0x1.8mm		

Parameter denoted with an asterisk ( \* )

Note1: Frequency stability includes 25C tolerance, operating temperature range , aging and input voltage or load change

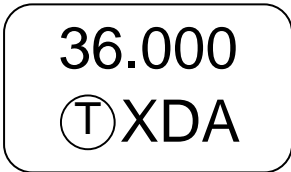
## Mechanical Dimensions (mm):



## Marking:

Line 1 : Frequency (36.000)

Line 2 :  $\text{\textcircled{T}}$ XDA (TST logo + Product Code + Data Code + TST Internal Code)



## Product Code Table

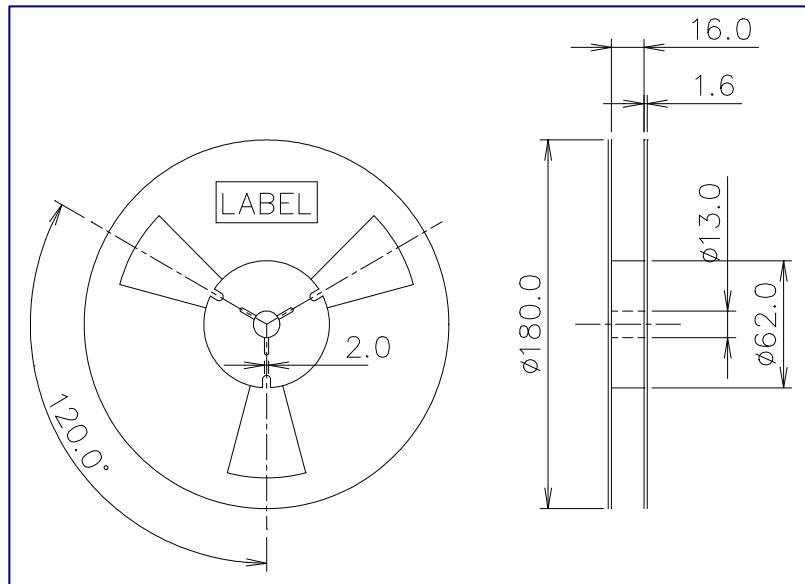
Year	2009 2013	2010 2014	2011 2015	2012 2016
Product Code	X	x	X	x

## Date Code Table

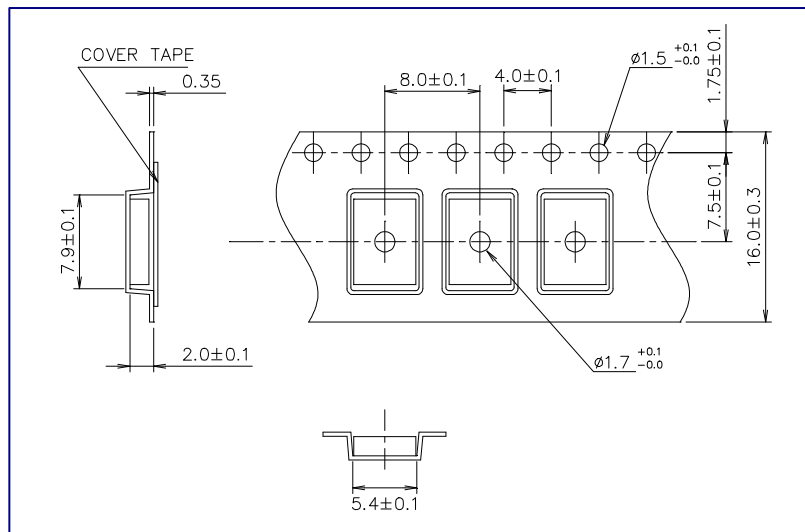
WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
A	B	C	D	E	F	G	H	I	J	K	L	M
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	O	P	Q	R	S	T	U	V	W	X	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
a	b	c	d	e	f	g	h	i	j	k	l	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	o	p	q	r	s	t	u	v	w	x	y	z

## Tape & Reel:

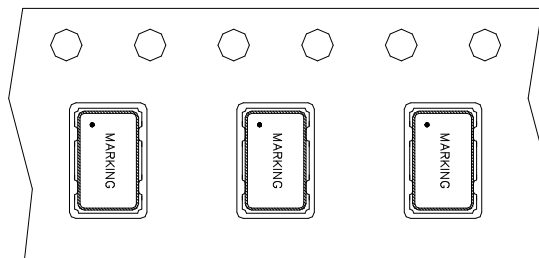
- Reel dimension (unit: mm)



- Tape dimension (unit: mm)

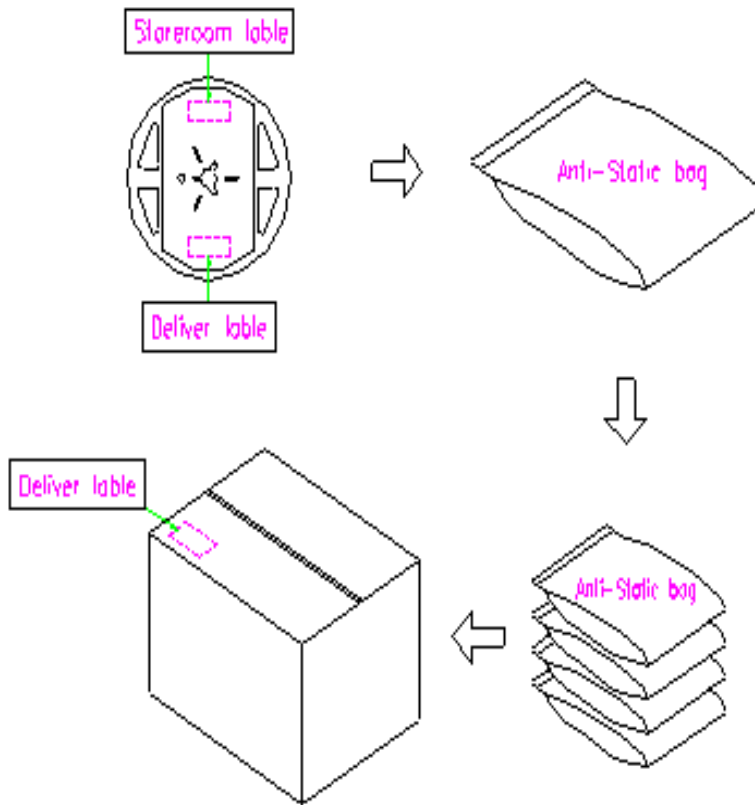


- Packing direction

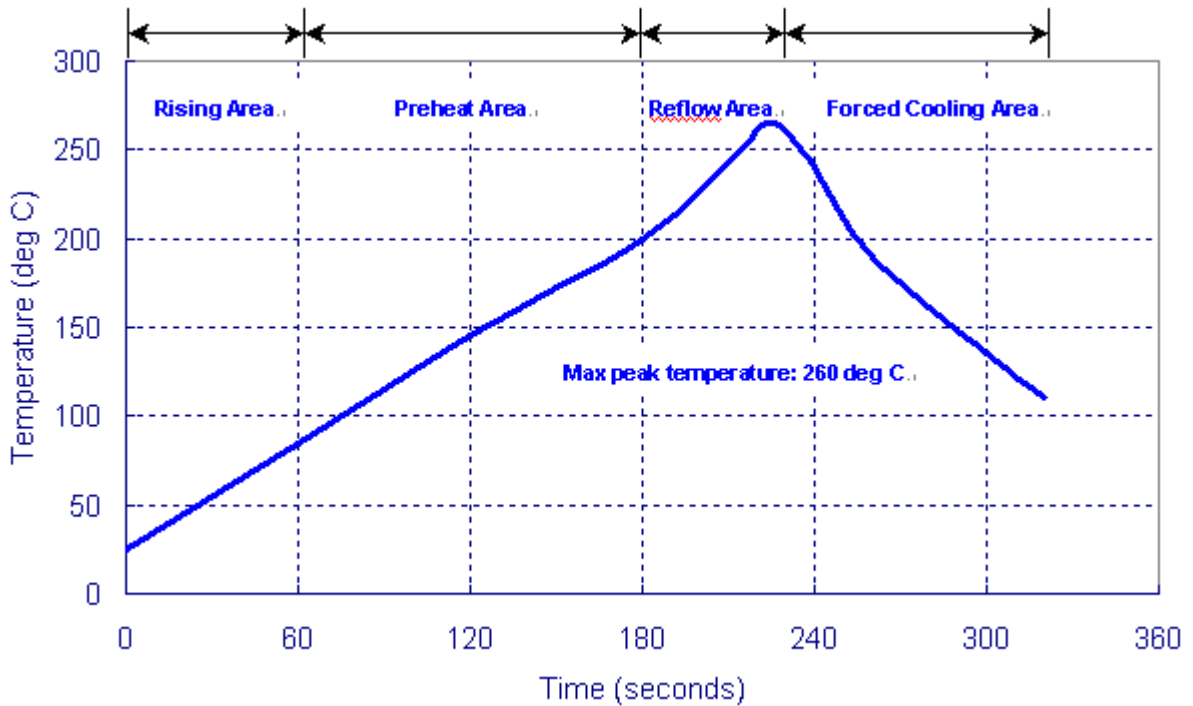


# Packing Quantity/Packing:

1K pcs maximum per reel



# Reflow Profile:



**Note: 1. Max peak temperature: 260 +/- 5 deg C; Time: 10 +/- 2 sec**  
**2. Temperature: 217 +/- 5 deg C; Time: 90 ~ 100 sec**

## Reliability Specifications

Test name	Test process / method	Reference standard
<b>Mechanical characteristics</b>		
resistance to Soldering heat (IR reflow)	Temp./ Duration : 260°C /10sec x2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 55 Hz Sweep period : 1.0 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202F method 201A
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202F method 213C
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	MIL-STD 883G method 2003
<b>Environmental characteristics</b>		
Thermal Shock	Heat cycle conditions -55 °C (30min) ↔ 125 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.7
Humidity test	Temperature : 70 ± 2 °C Relative humidity : 90~95% Duration : 96 hours	MIL-STD 202F method 103B
Dry heat ( Aging test )	Temperature : 125 ± 2 °C Duration : 168 hours	MIL-STD 883G method 1008.2 condition C
PCT test	Pressure: 2.06kg/cm <sup>2</sup> (2.03*10 <sup>5</sup> pa) Temperature : 121 ± 2 °C Relative humidity : 100% Duration : 24 hours	EIAJED-4701-3 B-123A